

Title (en)

System of floor elements and method for manufacturing the floor elements, and a method for manufacturing a floor construction using the floor elements

Title (de)

System von Bodenelementen und Verfahren zur Herstellung der Bodenelemente sowie Verfahren zur Herstellung einer Bodenkonstruktion mit den Bodenelementen

Title (fr)

Système d'éléments de plancher et procédé pour la fabrication d'éléments de plancher, et procédé pour la fabrication d'une construction de plancher utilisant les éléments de plancher

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Application

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Abstract (en)

[origin: EP1972735A1] The invention relates to a system of floor elements (2) which comprise thermally insulating material and are intended for placing on a substantially solid bottom as formwork for a ribbed floor to be arranged thereon. Each floor element is provided with a lower leg (12) for supporting on the bottom and with an upper leg (11) for supporting on a lower leg of a floor element (2) to be laid adjacently. The upper leg is provided on the underside thereof, and the lower leg on the upper side thereof, with co-acting profiles (13-16), this such that between adjacently placed floor elements there remains a free space (19) for the purpose of ventilation and a free space (18) for a rib. The invention also relates to a method for manufacturing the floor elements and to a method for manufacturing a floor construction using the system of floor elements according to the invention.

IPC 8 full level

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